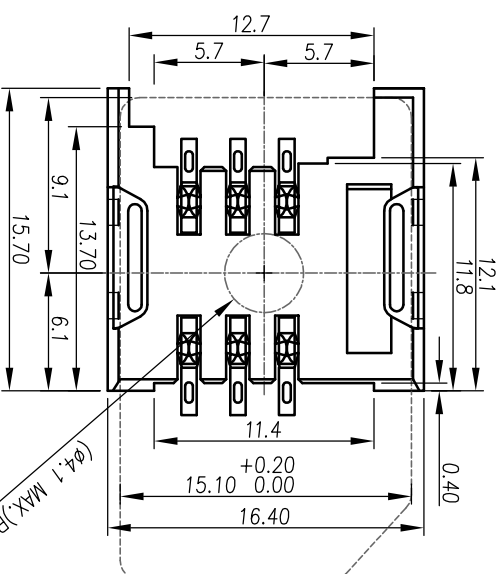
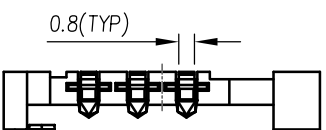


NOTES:

1.General Characteristics

Dimensions:15.70Lx16.40Wx2.80H mm

Weight: Approx. 0.5g

Contact principle:Friction technology

Operating position:Shaft up/Down/Horizontal

Mounting System:SMT

Durability:10,000 cycles min.

2.Material:

Insulation material: LCP.

3.Electrical Characteristics

Number of contacts:6 pins

Contact resistance:50 megohms typical,100 megohms max.

Insulation resistance:>1000 megohms /500 VDC

4.Solderability

Wave:Not applicable

Vaporphase:215°C,30 sec. MAX.

IR reflow:260°C,10~15 sec. MAX.

Manual soldering:360°C,3 sec. MAX.

5.Environmental Characteristics

Operating temperature:-40°C~+85°C

Operating humidity:10%~95%RH

Storage temperature:-40°C,+85°C

Storage humidity:10%~95%RH

Thermal shock:-40°C~+85°C, 5 cycles

Damp Heat:40°C,90%RH,500HR

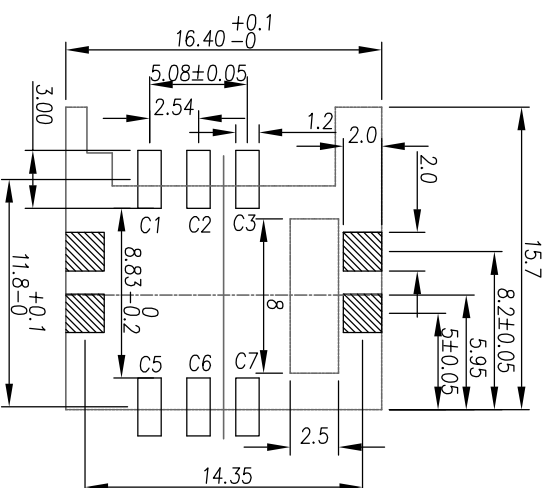
Salt-mist:35°C,5%,NaCl,48H

6.ORDER INFORMATION

SIMMP-006 XX B004-G

01:GOLD FLASH
30:30u

REV	MODIFICATION	DATE	DRAW
B	EN-05-0430	94/04/27	JOAN
C	EN-05-0511	94/05/12	JOAN
D	EN-06-1130	95/11/28	TERENCE



P.C.B. LAYOUT (TOLERANCES:±0.10mm)



KINGONT PRECISION INDUSTRIAL CO., LTD.

TITLE SIM CARD CONNECTOR

CUSTOMER DRAWING

FILE NO.

DWG NO. SIMMP-006XXB004-G

SIZE A4

PROJ. SCALE 2.5:1 SHEET 1 REV 1